Transistors

Panasonic

1.5±0.1

0.4±0.04

: Base 2: Collector 3. Emitter iP3-F1 Package

4.0+0.25 2.5±0.

.5+0 6+0 :

1.5±0

Unit: mm

2SC5026

Silicon NPN epitaxial planar type

For low-frequency output amplification Complementary to 2SA1890

Features

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- Low collector-emitter saturation voltage $V_{CE(sat)}$
- High collector-emitter voltage (Base open) V_{CEO}
- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing

Absolute Maximum Ratings $T_a = 25^{\circ}C$

	"							
Parameter	Symbol	Rating	Unit					
Collector-base voltage (Emitter open)	V _{CBO}	80	V					
Collector-emitter voltage (Base open)	V _{CEO}	80	V					
Emitter-base voltage (Collector open)	V _{EBO}	5	V					
Collector current	IC	1	A					
Peak collector current	I _{CP}	1.5	A	Marking Symbol: 2A				
Collector power dissipation *	P _C	1	W	10° . 10				
Junction temperature	Tj	150	°C	VO CONT				
Storage temperature	T _{stg}	-55 to +150	°C	OUT OUL				
Note) *: Copper plate at the collector is more than 1 cm ² in area, 1.7 mm in thickness								
Absolute maximum rating without heat sink for P _C is 0.5 W								
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$								

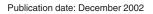
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{\rm C} = 10 \ \mu A_{\rm C} I_{\rm E} = 0$	80			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 1$ mA, $I_{\rm B} = 0$	80			V
Emitter-base voltage (Collector open)	V _{EBO}	$J_E = 10 \ \mu A G_C = 0$	5			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 40$ V, $I_E = 0$			0.1	μΑ
Forward current transfer ratio	h _{FE1}	$V_{CE} = 2 \text{ V}, I_{C} = 100 \text{ mA}$	120		340	—
	hFE2 *1	$V_{CE} = 2 \text{ V}, \text{ I}_{C} = 500 \text{ mA}$	60			
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$		0.15	0.3	V
Base-emitter saturation voltage *1	V _{BE(sat)}	$I_{C} = 500 \text{ mA}, I_{B} = 50 \text{ mA}$		0.85	1.2	V
Transition frequency	f _T	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		120		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		10	20	pF
(Common base, input open circuited)						

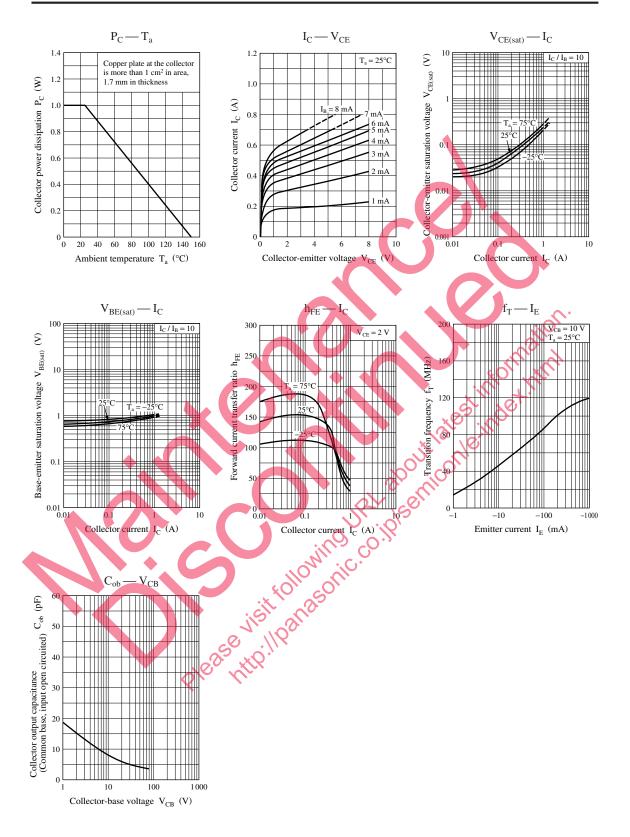
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *1: Pulse measurement

*2: Rank classification						
Rank	R	S				
h _{FE1}	120 to 240	170 to 340				



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